Preliminary Information

6.0 A H-Bridge with Enable

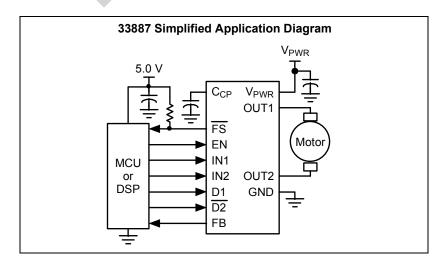
The 33887 is a monolithic H-Bridge with a Sleep Mode feature ideal for fractional horsepower DC-motor and bi-directional thrust solenoid control. The IC incorporates internal control logic, charge pump, gate drive, and low $R_{\rm DS(ON)}$ MOSFET output circuitry. The 33887 is able to control continuous inductive DC load currents of 6.0 A. Output loads can be Pulse Width Modulation (PWM) controlled at frequencies to 10 kHz. An internal output current monitoring circuit provides a proportional (1/375th) feedback current output for the microcontroller to monitor the output current and provide closed-loop control.

A Fault Status output reports undervoltage, overcurrent, and overtemperature conditions. Two independent inputs provide polarity control of two half-bridge totem-pole outputs. Two disable inputs force the H-Bridge outputs to tristate (exhibit high impedance).

The 33887 is parametrically specified over a temperature range of -40°C \leq $T_A \leq$ 125°C, 5.0 V \leq $V_{PWR} \leq$ 28 V, and is available in three different surface mount packages.

Features

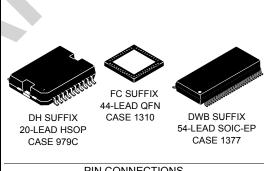
- 5.0 V to 36 V Operation
- 120 m Ω R_{DS(ON)} H-Bridge Switches
- TTL/CMOS Compatible Inputs
- · PWM Frequencies to 10 kHz
- · Automatic PWM Overcurrent Limiting
- · Output Short Circuit Protection
- · Overtemperature Output Current Reduction with Shutdown
- Undervoltage Shutdown
- Fault Status Reporting
- High-Side Current Feedback Output Provides Real-Time Current Monitoring



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33887

6.0 A H-BRIDGE WITH ENABLE



	PIN CONNECTIONS									
HSOP	Q	FN	S	OIC						
1 AGND 2 FS 3 IN1 4 VPWR 5 VPWR 6 OUT1 7 OUT1 8 FB 9 PGND 10 PGND 11 PGND 11 PGND 12 PGND 13 D2 14 OUT2 15 OUT2 16 VPWR 17 CCP 18 D1 19 IN2 20 EN	1 FB 2 PGND 3 PGND 4 PGND 5 PGND 6 PGND 7 PGND 8 PGND 9 PGND 10 D2 11 OUT2 12 OUT2 13 NC 14 NC 15 NC 16 NC 17 OUT2 18 OUT2 19 VPWR 21 C _{CP} 22 D1	23 IN2 24 EN 25 NC 26 NC 27 VPWR 28 VPWR 30 VPWR 31 NC 32 NC 33 AGND 34 FS 35 IN1 36 VPWR 38 OUT1 40 NC 41 OUT1 42 OUT1 43 NC 44 NC	1 PGND 2 PGND 2 PGND 3 PGND 4 PGND 5 NC 6 NC 7 NC 8 D2 9 NC 10 OUT2 11 OUT2 12 OUT2 13 OUT2 14 NC 15 VPWR 17 VPWR 17 VPWR 18 VPWR 19 NC 20 NC 21 NC 22 NC 23 CCP 24 D1 25 IN2 26 EN 27 NC	28 NC 29 NC 30 AGND 31 FS 32 IN1 33 NC 34 NC 35 NC 36 NC 37 VPWR 38 VPWR 40 VPWR 41 NC 42 OUT1 44 OUT1 45 OUT1 44 OUT1 45 OUT1 46 NC 47 FB 48 NC 49 NC 50 NC 51 PGND 52 PGND 54 PGND						

ORDERING INFORMATION

Device	Temperature Range (T _A)	Package
PC33887DH/R2	-40 to 125°C	20 HSOP
PC33887FC/R2	-40 to 125°C	44 QFN
PC33887DWB/R2	-40 to 125°C	54 SOIC-EP





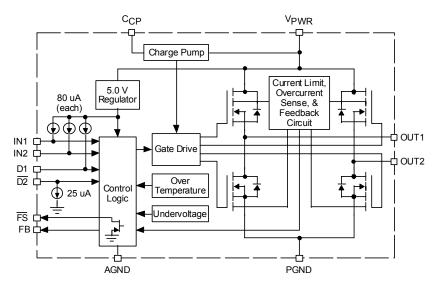


Figure 1. 33887 Internal Block Diagram

PIN FUNCTION DESCRIPTION

HSOP	QFN	SOIC	Pin Name	Description
1	33	30	AGND	Low current Analog signal ground.
2	34	31	FS	Open drain active LOW Fault Status output requiring a pull-up resistor to 5.0 V.
3	35	32	IN1	True Logic input control of OUT1 (i.e., IN1 logic HIGH = OUT1 HIGH).
4, 5, 16	19, 20, 27–30	15–18, 37–40	V _{PWR}	Positive power source connection.
6, 7	38, 39, 41, 42	42–45	OUT1	H-Bridge output 1.
8	1	47	FB	Current sensing feedback output providing ground referenced 1/375th (0.00266) of H-Bridge high-side output current.
9–12	2–9, 36, 37	1–4, 51–54	PGND	Device high current power ground.
13	10	8	D2	Active LOW input used to simultaneously tristate disable both H-Bridge outputs. When $\overline{\rm D2}$ is Logic LOW, both outputs are tristate.
14, 15	11, 12, 17, 18	10–13	OUT2	H-Bridge output 2.
17	21	23	C _{CP}	External reservoir capacitor connection for internal Charge Pump.
18	22	24	D1	Active HIGH input used to simultaneously tristate disable both H-Bridge outputs. When D1 is Logic HIGH, both outputs are tristate.
19	23	25	IN2	True Logic input control of OUT2 (i.e., IN2 logic HIGH = OUT2 HIGH).
20	24	26	EN	True Logic input Enable control of device (i.e., EN logic High = Full Operation, EN logic LOW = Sleep Mode).
-	13–16, 25, 26, 31, 32, 40, 43, 44	5–7, 9, 14, 19–22, 27–29, 33–36, 41, 46, 48–50	NC	No internal connection to this pin.

MAXIMUM RATINGS

All voltages are with respect to ground unless otherwise noted.

Rating	Symbol	Value	Unit
Power Supply Voltage			
Normal Operation (Steady-State)	$V_{PWR(SS)}$	36	V
Transient (Note 1)	$V_{PWR(t)}$	40	
Input Voltage (Note 2)	V _{IN}	7.0	V
FS Status Output (Note 3)	V _{FS}	7.0	V
Continuous Output Current (Note 4)	I _{OUT(CONT)}	6.0	А
ESD Voltage			
Human Body Model (Note 5)	V _{ESD1}	TBD	V
Machine Model (Note 6)	V _{ESD2}	200	
Storage Temperature	T _{STG}	-65 to 150	°C
Ambient Temperature (Note 7)	T _A	-40 to 125	°C
Operating Junction Temperature	T _J	-40 to 150	°C
Lead Soldering Temperature (Note 8)	T _{SOLDER}	260	°C
Approximate Junction-to-Board Thermal Resistance (Note 9)	$R_{ heta J-B}$		
HSOP		~5.0	°C/W
QFN		~18	C/ V V
SO-EP		~12	

- 1. Device will survive the transient overvoltage indicated for a maximum duration of 500 ms.
- 2. Exceeding the input voltage on IN1, IN2, EN, D1, or $\overline{D2}$ may cause a malfunction or permanent damage to the device.
- 3. Exceeding the pull-up resistor voltage on the open Drain \overline{FS} pin may cause permanent damage to the device.
- 4. Continuous output current capability so long as junction temperature is ≤ 150°C.
- 5. ESD1 testing is performed in accordance with the Human Body Model (C_{ZAP} = 100 pF, R_{ZAP} = 1500 Ω).
- 6. ESD2 testing is performed in accordance with the Machine Model (C_{ZAP} = 100 pF, R_{ZAP} = 0 Ω).
- 7. The limiting factor is junction temperature, taking into account the power dissipation, thermal resistance, and heat sinking.
- 8. Lead soldering temperature limit is for 10 seconds maximum duration. Not designed for immersion soldering. Exceeding these limits may cause malfunction or permanent damage to the device.
- Exposed heat sink pad plus the power and ground terminals comprise the main heat conduction paths. The actual R_{θJ-B} (junction-to-PC board) values will vary depending on solder thickness and composition and copper trace.

STATIC ELECTRICAL CHARACTERISTICS

Characteristics noted under conditions $5.0 \text{ V} \le \text{V}_{\text{PWR}} \le 28 \text{ V}$ and $-40^{\circ}\text{C} \le \text{T}_{\text{A}} \le 125^{\circ}\text{C}$, unless otherwise noted. Typical values noted reflect the approximate parameter mean at $\text{T}_{\text{A}} = 25^{\circ}\text{C}$ under nominal conditions, unless otherwise noted.

Characteristic	Symbol	Min	Тур	Max	Unit
Power Supply		1	•		
Operating Voltage Range (Note 10)					
Steady-State	$V_{PWR(SS)}$	5.0	_	36	V
Transient (t < 500 ms) (Note 11)	$V_{PWR(t)}$	_	_	40	V
Sleep State Supply Current (Note 12)	I _{PWR(sleep)}				
V _{EN} = 0 V, I _{LOUT} = 0 A		-	25	50	μΑ
Standby Supply Current	I _{PWR(standby)}				
I _{LOUT} = 0 A, V _{EN} = 5.0 V		-	-	20	mA
Threshold Supply Voltage					
Switch-OFF	V _{PWR(thres-OFF)}	4.15	4.4	4.65	V
Switch-ON	V _{PWR(thres-ON)}	4.5	4.75	5.0	V
Hysteresis	V _{PWR(hys)}	150	-	-	mV
Charge Pump		I	I .		ı
Charge Pump Voltage					
V _{PWR} = 4.15 V	$V_{CP} - V_{PWR}$	3.35	_	_	V
V _{PWR} < 40 V		_	_	20	V
Control Inputs		ļ			
Input Voltage (IN1, IN2, D1, D2)					
Threshold HIGH	V _{IH}	3.5	_	_	V
Threshold LOW	V _{IL}	_	_	1.4	V
Hysteresis	V _{HYS}	0.7	1.0	_	V
Input Current (IN1, IN2, D1)					
V _{IN} - 0.0 V	I _{IN}	-200	-80	-	μA
Input Current (D2, EN)					
V _{D2} = 5.0 V	I D2	_	25	100	μΑ

- 10. Parameter is guaranteed by design but not production tested.
- 11. Device will survive the transient overvoltage indicated for a maximum duration of 500 ms.
- 12. I_{PWR(sleep)} is with sleep mode function Enabled.

STATIC ELECTRICAL CHARACTERISTICS (continued)

Characteristics noted under conditions 5.0 V \leq V_{PWR} \leq 28 V and -40°C \leq T_A \leq 125°C, unless otherwise noted. Typical values noted reflect the approximate parameter mean at T_A = 25°C under nominal conditions, unless otherwise noted.

Characteristic	Symbol	Min	Тур	Max	Unit
Power Outputs (OUT1, OUT2)					
Output-ON Resistance (Note 13)	R _{OUT}				
5.0 V < V _{PWR} < 28 V, T _J = 25°C		_	120	-	mΩ
8.0 V < V _{PWR} < 28 V, T _J = 150°C		_	-	225	$m\Omega$
5.0 V < V _{PWR} < 8.0 V, T _J = 150°C		_	_	300	mΩ
Output Latch-OFF Current	I _{LATCH-OFF}	6.0	7.0	8.5	А
Output Latch-OFF Time	t _a	15	20.5	26	μs
Output Blanking Time	t _b	12	16.5	21	μs
High-Side Overcurrent Detection	I _{OCD(H)}	11	-	-	А
Low-Side Overcurrent Detection	I _{OCD(L)}	9.0	-	-	Α
Leakage Current (Note 14)	I _{OUT(leak)}				
V _{OUT} = V _{PWR}	o o i (iouil)	_	100	200	μΑ
V _{OUT} = GND		-	30	60	μΑ
Free-Wheeling Diode Forward Voltage Drop (Note 15)	V _F				
I _{OUT} = 3.0 A		-	-	2.0	V
Free-Wheeling Diode Reverse Recovery Time (Note 15)	t _{rr}	100	-	-	ns
Switch-OFF					
Thermal Shutdown	T _{LIM}	175	-	-	°C
Hysteresis	T _{HYS}	10	-	30	°C

- 13. Output-ON resistance as measured from output to $\ensuremath{V_{\text{PWR}}}$ and GND.
- 14. Outputs switched OFF with D1 or $\overline{D2}$.
- 15. Parameter is guaranteed by design but not production tested.

STATIC ELECTRICAL CHARACTERISTICS (continued)

Characteristics noted under conditions $5.0 \text{ V} \le V_{PWR} \le 28 \text{ V}$ and $-40^{\circ}\text{C} \le T_{A} \le 125^{\circ}\text{C}$, unless otherwise noted. Typical values noted reflect the approximate parameter mean at T_{A} = 25°C under nominal conditions, unless otherwise noted.

Characteristic	Symbol	Min	Тур	Max	Unit
High-Side Current Sense Feedback					ı
Feedback Current	I _{FB}				
$I_{LOAD} = 0 \text{ mA}$		-	_	600	μΑ
I _{LOAD} = 500 mA		1.07	-1.33	1.60	mA
I _{LOAD} = 1.5 A		3.6	4.0	4.4	mA
$I_{LOAD} = 3.0 A$		7.2	8.0	8.8	mA
$I_{LOAD} = 6.0 A$		14.4	16.0	17.6	mA
Fault Status (Note 16)		<u>I</u>	I	<u>I</u>	ı
Fault Status Leakage Current (Note 17)	I FS (leak)				
V _{FS} = 5.0 V		-	_	10	μΑ
Fault Status SET Voltage (Note 18)	V _{FS(LOW)}				
I _{FS} = 300 μA	. 3(23.11)	_	_	1.0	V

- 16. Fault Status output is an open Drain output requiring a pull-up resistor to 5.0 V.
- 17. Fault Status Leakage Current is measured with Fault Status HIGH and not SET.
- 18. Fault Status Set Voltage is measured with Fault Status LOW and SET with $I_{\overline{FS}}$ = 300 μ A.

DYNAMIC ELECTRICAL CHARACTERISTICS

Characteristics noted under conditions 5.0 V \leq V_{PWR} \leq 28 V and -40°C \leq T_A \leq 125°C, unless otherwise noted. Typical values noted reflect the approximate parameter mean at T_A = 25°C under nominal conditions, unless otherwise noted.

Characteristic	Symbol	Min	Тур	Max	Unit
Timing Characteristics	•	•			•
PWM Frequency (Note 19)	f _{PWM}	_	_	10	kHz
Maximum Switching Frequency During Current Limit (Note 20)	f _{MAX}	-	-	20	kHz
Output ON Delay (Note 21) $V_{PWR} = 14 \text{ V}$	t _{d(ON)}	_	_	18	μs
Output OFF Delay (Note 21) $V_{PWR} = 14 \text{ V}$	t _{d(OFF)}	_	_	18	μs
Output Rise and Fall Time (Note 22) $V_{PWR} = 14 \text{ V}, I_{out} = 3.0 \text{ A}$	t _f , t _r	2.0	5.0	8.0	μs
Disable Delay Time (Note 23)	t _{d(disable)}	-	-	8.0	μs
Over-Current/Temperature Turn-OFF Time (Note 24)	t _{FAULT}	_	4.0	-	μs
Power-OFF Delay Time (Note 25)	t _{pod}	_	1.0	5.0	ms

- 19. The outputs can be PWM controlled from an external source. The PWM Frequency is the externally induced output switching frequency, the maximum frequency of which is limited by the internal charge pump.
- 20. The Maximum Switching Frequency during Current Limit is internally implemented. The internal control produces a constant OFF-time PWM of the output. The output load current effects the Maximum Switching Frequency.
- 21. Output Delay is the time duration from the midpoint of the IN1 or IN2 input signal to the 10% or 90% point (dependent on the transition direction) of the OUT1 or OUT2 signal. If the output is transitioning HIGH-to-LOW, the delay is from the midpoint of the input signal to the 90% point of the output response signal. If the output is transitioning LOW-to-HIGH, the delay is from the midpoint of the input signal to the 10% point of the output response signal. See Figure 3.
- $22. \quad \text{Rise Time is from the } 10\% \text{ to the } 90\% \text{ level and Fall Time is from the } 90\% \text{ to the } 10\% \text{ level of the output signal. See Figure 4}.$
- 23. Disable Delay Time is the time duration from the midpoint of the D (disable) input signal to 10% of the output tristate response. See Figure 3.
- 24. Increasing output currents will become limited at 6.5 A. Hard shorts will breach the 6.5 A limit, forcing the output into an immediate tristate latch-OFF. See Figure 5 and Figure 6. Output current limiting will cause junction temperatures to rise. A junction temperature above 160°C will cause the output current limit to progressively "fold-back" or decrease to 2.5 A typical at 175°C where thermal latch-OFF will occur. See Figure 7
- 25. This parameter has been characterized but is not production tested.

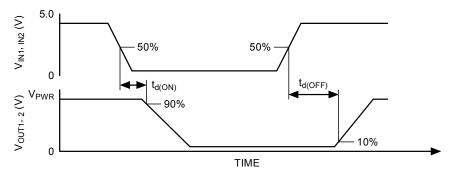


Figure 2. Output Delay Time

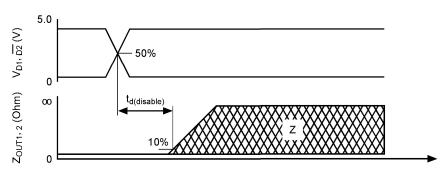


Figure 3. Disable Delay Time



Figure 4. Output Switching Time

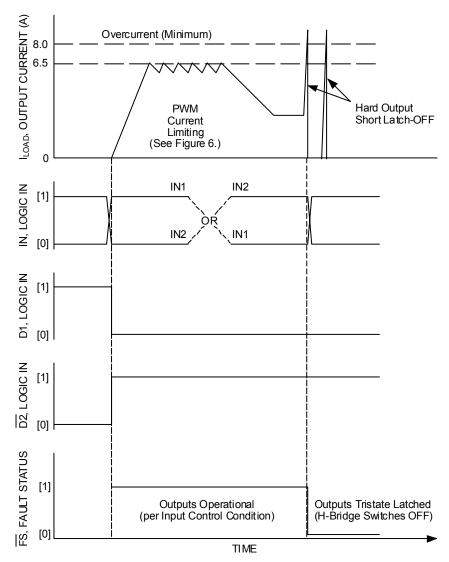


Figure 5. Output Load Current Limiting Versus Time

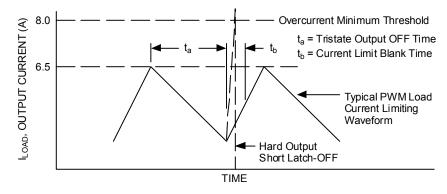


Figure 6. PWM Current Limiting Detail

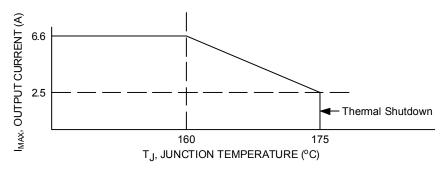


Figure 7. Maximum Output Current Limiting Versus Temperature

Table 1. Truth Table

The tristate conditions and the fault status are reset using D1 or $\overline{D2}$. The truth table uses the following notations: L = Low, H = High, X = High or Low, and Z = High impedance (all output power transistors are switched off).

			Input Co	nditions		Status	Outputs		
Device State	EN	D1	D2	IN1	IN2	FS	OUT1	OUT2	
Forward	Н	L	Н	Н	L	Н	Н	L	
Reverse	Н	L	Н	L	Н	Н	L	Н	
Free Wheeling Low	Н	L	Н	L	L	Н	L	L	
Free Wheeling High	Н	L	Н	Н	Н	Н	Н	Н	
Disable 1 (D1)	Н	Н	Х	Х	Х	L	Z	Z	
Disable 2 (D2)	Н	Х	L	Х	Х	L	Z	Z	
IN1 Disconnected	Н	L	Н	Z	Х	Н	Н	Х	
IN2 Disconnected	Н	L	Н	Х	Z	Н	Х	Н	
D1 Disconnected	Н	Z	Х	Х	Х	L	Z	Z	
D2 Disconnected	Н	Х	Z	Х	Х	L	Z	Z	
Undervoltage (Note 26)	Н	Х	Х	Х	Х	L	Z	Z	
Overtemperature (Note 27)	Н	Х	Х	Х	Х	L	Z	Z	
Overcurrent (Note 27)	Н	Х	Х	Х	Х	L	Z	Z	
Sleep Mode EN	L	Х	Х	Х	Х	Н	Z	Z	
EN Disconnected	Z	Х	Х	Х	Х	Н	Z	Z	

^{26.} In the case of an undervoltage condition, the outputs tristate and the fault status is SET logic LOW. Upon undervoltage recovery, fault status is reset automatically or automatically cleared and the outputs are restored to their original operating condition.

^{27.} When an overcurrent or overtemperature condition is detected, the power outputs are tristate latched-OFF independent of the input signals and the fault status flag is SET logic LOW.

SYSTEM/APPLICATION INFORMATION

INTRODUCTION

Numerous protection and operational features (speed, torque, direction, dynamic breaking, PWM control, and closed-loop control), in addition to the 6.0 A output current capability, make the 33887 a very attractive cost-effective solution for controlling a broad range of fractional horsepower DC-motors. A pair of 33887 devices can be used to control bipolar stepper motors in both directions. In addition, the 33887 can be used to control permanent magnet solenoids in a push-pull variable force fashion using PWM control. The 33887 can also be used to excite transformer primary windings with a switched square wave to produce secondary winding AC currents.

As shown in Figure 1, Internal Block Diagram, the 33887 is a fully protected monolithic H-Bridge with Enable, Fault Status reporting, and High-Side current sense feedback to accommodate closed-loop PWM control. For a DC-motor to run the input conditions need be as follows: Enable input logic HIGH, D1 input logic LOW, $\overline{\rm D2}$ input logic HIGH, $\overline{\rm FS}$ flag cleared (logic HIGH), with one IN logic LOW and the IN other logic HIGH to define output polarity. The 33887 can execute Dynamic Breaking by simultaneously turning-ON either the two High-Side or the two Low-Side H-Bridge switches; e.g., IN1 and IN2 logic HIGH or IN1 and IN2 logic LOW.

The 33887 outputs are capable of providing a continuous DC load current of 6.0 A from a 36 V V_{PWR} source. An internal charge pump supports PWM frequencies to $10\,\text{kHz}$. An external pull-up resistor is required for the open drain \overline{FS} pin for fault status reporting. The 33887 has a current feedback output (FB)

for "real time" monitoring of output current to facilitate closedloop operation for motor speed and torque control.

Two independent inputs (IN1 and IN2) provide control of the two totem-pole half-bridge outputs. Two disable inputs (D1 and $\overline{D2}$) are for forcing the H-Bridge outputs to a high impedance state (all H-Bridge switches OFF). An EN pin controls an enable function that allows the 33887 to be placed in a power-conserving sleep mode.

The 33887 has Undervoltage Shutdown with automatic recovery, Output Current Limiting, Output Short-Circuit Latch-OFF, and Overtemperature Latch-OFF. An Undervoltage Shutdown, Output Short-Circuit Latch-OFF, or Overtemperature Latch-OFF fault condition will cause the outputs to turn-OFF (tristate) and the fault output flag to be set LOW. Either of the D inputs or V_{PWR} must be "toggled" to clear the fault flag. The Overcurrent/Overtemperature Shutdown scheme is unique and best described as using a junction temperature dependent output current "fold back" protection scheme. When an overcurrent condition is experienced, the current limited output is "ramped down" as the junction temperature increases above 160°C, until at 175°C the output current has decreased to about 2.5 A. Above 175°C, the Overtemperature Shutdown (Latch-OFF) occurs. This feature allows the device to remain in operation for a longer time with unexpected loads, but with regressive output performance at junction temperatures above 160°C.

FUNCTIONAL PIN DESCRIPTION

PGND and **AGND**

Power and analog ground pins. The power and analog ground pins should be connected together with a very low impedance connection.

\mathbf{V}_{PWR}

 V_{PWR} pins are the power supply inputs to the device. All V_{PWR} pins must be connected together on the printed circuit board with as short as possible traces offering as low impedance as possible between pins.

 V_{PWR} pins have an undervoltage threshold. If the supply voltage drops below a V_{PWR} undervoltage threshold, the output power stage switches to a tristate condition and the fault status flag is SET and the Fault Status pin voltage switched to a logic LOW. When the supply voltage returns to a level that is above the threshold, the power stage automatically resumes normal operation according to the established condition of the input pins and the fault status flag is automatically reset logic HIGH.

Fault Status (FS)

This pin is the device fault status output. This output is an active LOW open drain structure requiring a pull-up resistor to 5.0 V. Refer to Table 1, Truth Table.

IN1, IN2, D1, D2

These pins are input control pins used to control the outputs. These pins are 5.0 V CMOS-compatible inputs with hysteresis. The IN1 and IN2 independently control OUT1 and OUT2, respectively. D1 and $\overline{\text{D2}}$ are complimentary inputs used to tristate disable the H-Bridge outputs.

When either D1 or $\overline{D2}$ is SET (D1 = logic HIGH or $\overline{D2}$ = logic LOW) in the disable state, outputs OUT1 and OUT2 are both tristate disabled; however, the rest of the device circuitry is fully operational and the supply $I_{PWR(standby)}$ current is reduced to a few milli-amperes. See Table 1, Truth Table, and STATIC ELECTRICAL CHARACTERISTICS (continued) table.

OUT1, OUT2

These pins are the outputs of the H-Bridge with integrated free-wheeling diodes. The bridge output is controlled using the IN1, IN2, D1, and $\overline{D2}$ inputs. The outputs have Pulse Width

Modulated (PWM) current limiting above 6.5 A. The outputs also have thermal shutdown (tristate latch-OFF) with hysteresis as well as short circuit latch-OFF protection.

A disable timer (time t_b) incorporated to detect currents that are higher than current limit is activated at each output activation to facilitate detecting hard output short conditions. See Figure 6.

CCP

Charge pump output pin. A filter capacitor (up to 33 nF) can be connected from the C_{CP} pin and PGND. The device can operate without the external capacitor, although the C_{CP} capacitor helps to reduce noise and allows the device to perform at maximum speed, timing, and PWM frequency.

ΕN

The EN pin is used to place the device in a sleep mode so as to consume very low currents. When the EN pin voltage is a logic LOW state, the device is in the sleep mode. The device is enabled and fully operational when the EN pin voltage is logic HIGH. An internal pull-down resistor maintains the device in sleep mode in the event EN is driven through a high impedance

I/O or an unpowered microcontroller, or the EN input becomes disconnected.

FΒ

The device has a feedback output (FB) for "real time" monitoring of H-Bridge high-side output currents to facilitate closed-loop operation for motor speed and torque control.

The FB pin provides current sensing feedback of the H-Bridge high-side drivers. When running in the forward or reverse direction, a ground referenced 1/375th (0.00266) of load current is output to this pin. Through the use of an external resistor to ground, the proportional feedback current can be converted to a proportional voltage equivalent and the controlling microcontroller can "read" the current proportional voltage with its analog to digital converter (ADC). This is intended to provide the user with motor current feedback for motor torque control. The accuracy is \pm 20% at load currents <1.5 A and \pm 10% at load currents >1.5 A.

If PWM-ing is implemented using the disable pin inputs (either D1 or $\overline{D2}$), a small filter capacitor (<1.0 μ F) may be required in parallel with the external resistor to ground for fast spike suppression.

PERFORMANCE FEATURES

Short Circuit or Overcurrent Protection

If an output overcurrent condition is detected, the power outputs tristate latched-OFF independent of the input signal states and the fault status output flag is SET logic LOW. If the D1 voltage changes from logic HIGH to logic LOW or from logic LOW to logic HIGH on $\overline{D2}$, the output switches ON again and the fault status flag is reset (cleared) to a logic HIGH state.

The output stage will always switch into the mode defined by the input pins (IN1, IN2, D1, and $\overline{D2}$), provided the device junction temperature is within the specified operating temperature.

PWM Current Limiting

The maximum current flow under normal operating conditions is limited to I_{MAX} (6.0 to 8.5 A). When the maximum current value is reached, the output stages are tristated for a fixed time (t_a) of 20 μs typical. Depending on the time constant associated with the load characteristics, the output current decreases during the tristate duration until the next output ON cycle occurs. See Figure 6.

The PWM current limitation value is dependent upon the device junction temperature. When -40°C < $T_{\rm J}$ < 160°C, $I_{\rm MAX}$ is between 6.0 and 8.5 A. When $T_{\rm J}$ exceeds 160°C, the $I_{\rm MAX}$ current decreases linearly down to 2.5 A typical at 175°C typical (or where the device reaches $T_{\rm LIM}$) and overtemperature shutdown occurs. See Figure 7. This feature allows the device to remain operational for a longer time but at a regressing output performance level at junction temperatures above $160^{\circ}{\rm C}$.

Overtemperature Shutdown and Hysteresis

If an overtemperature condition occurs, the power outputs are tristate latched-OFF independent of the input signals and the fault status flag is SET logic LOW.

If the D1 voltage changes from logic HIGH to logic LOW or from logic LOW to logic HIGH on logic the output stage switches ON again, providing the temperature is below the overtemperature threshold limit minus the hysteresis. The fault status flag is reset (cleared) logic HIGH.

APPLICATIONS

A typical application schematic is shown in Figure 8. For precision high-current applications in harsh, noisy

environments, the V_{PWR} by-pass capacitor may need to be substantially larger.

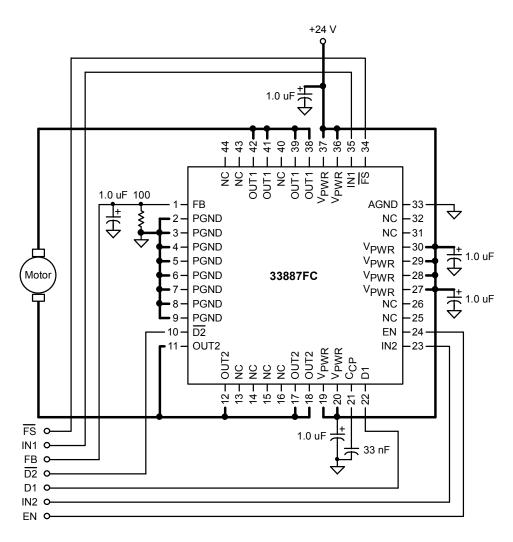
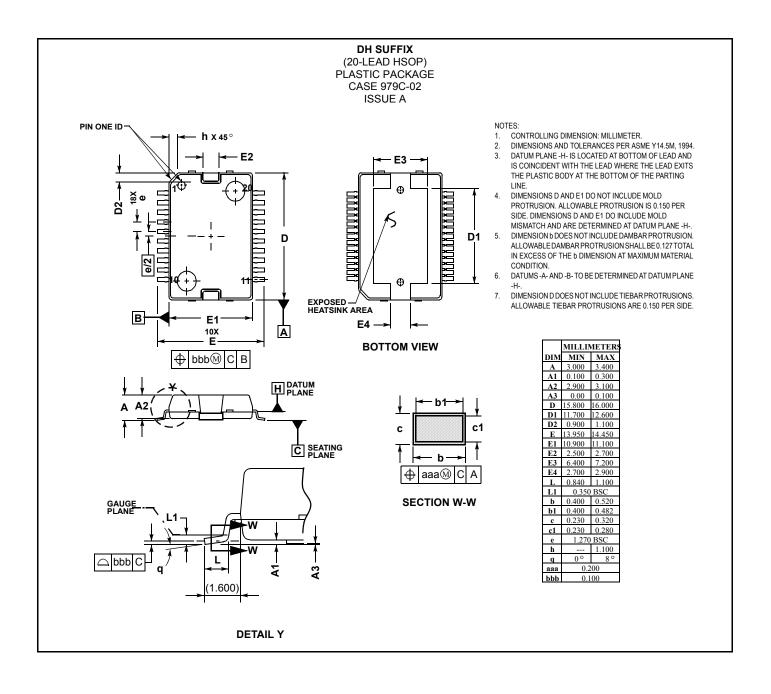
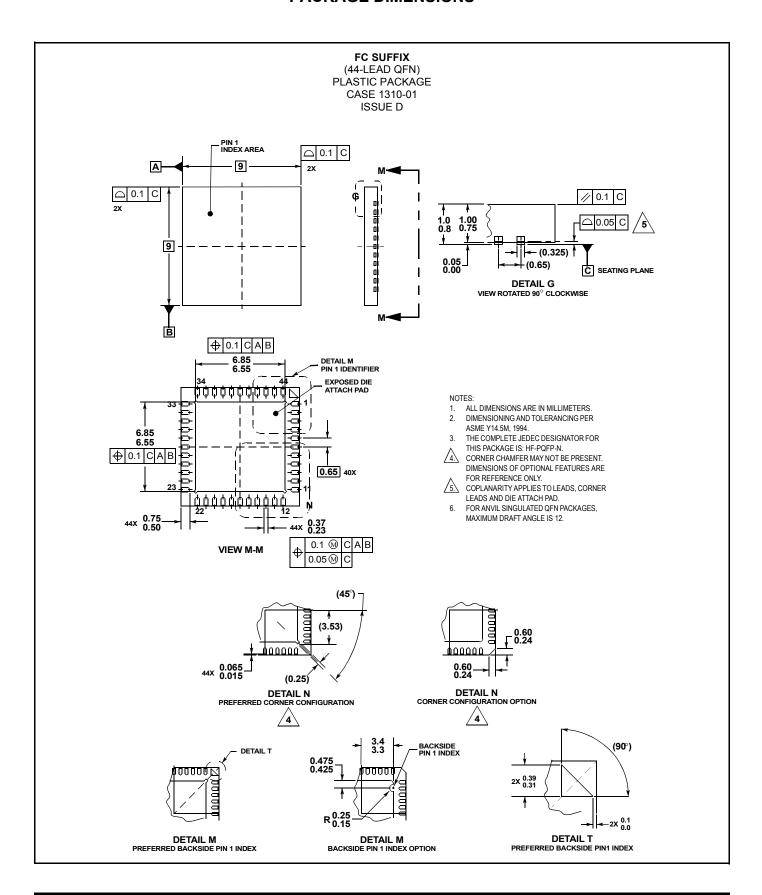


Figure 8. Typical Application Schematic

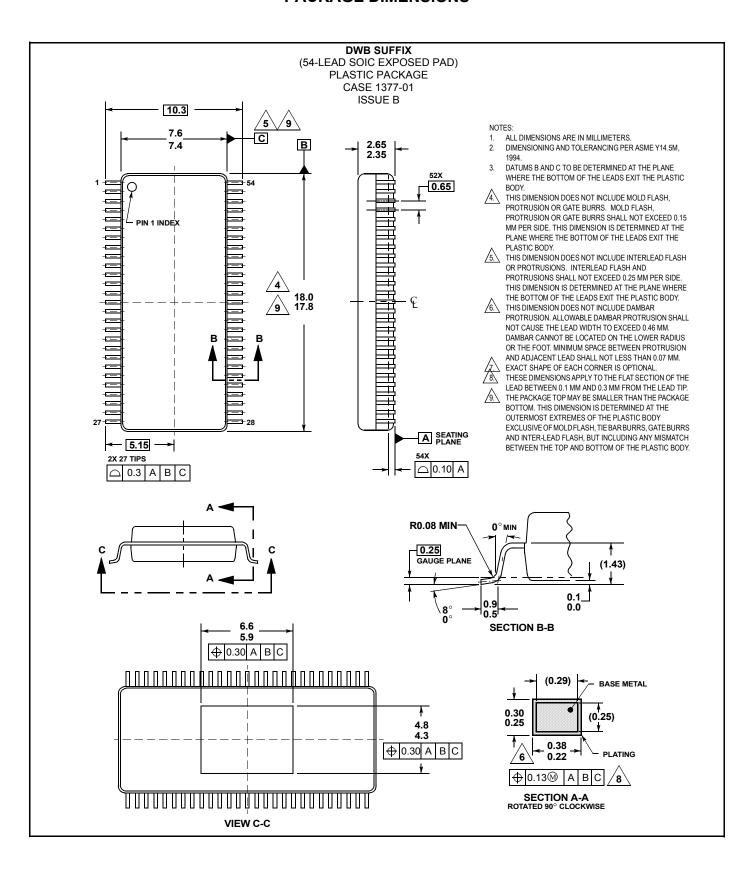
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HOW TO REACH US:

USA/EUROPE/LOCATIONS NOT LISTED: Motorola Literature Distribution: P.O. Box 5405, Denver, Colorado 80217.

1-303-675-2140 or 1-800-441-2447

JAPAN: Motorola Japan Ltd.; SPS, Technical Information Center, 3-20-1 Minami-Azabu. Minato-ku, Tokyo 106-8573 Japan.

81-3-3440-3569

ASIA/PACIFIC: Motorola Semiconductors H.K. Ltd.; Silicon Harbour Centre, 2 Dai King Street, Tai Po Industrial Estate, Tao Po, N.T.,

Hong Kong. 852-26668334

TECHNICAL INFORMATION CENTER: 1-800-521-6274

